

**LT1004C-1.2, LT1004C-2.5, LT1004I-1.2, LT1004I-2.5, LT1004M-1.2
LT1004M-2.5, LT1004Y-1.2, LT1004Y-2.5**
MICROPOWER INTEGRATED VOLTAGE REFERENCES

SLVS022F – JANUARY 1989 – REVISED MARCH 1998

● **Initial Accuracy**

- ±4 mV for LT1004-1.2
- ±20 mV for LT1004-2.5

● **Micropower Operation**

● **Operates up to 20 mA**

● **Very Low Reference Impedance**

● **Applications:**

- Portable Meter Reference
- Portable Test Instruments
- Battery-Operated Systems
- Current-Loop Instrumentation

description

The LT1004 micropower voltage reference is a two-terminal band-gap reference diode designed to provide high accuracy and excellent temperature characteristics at very low operating currents. Optimizing the key parameters in the design, processing, and testing of the device results in specifications previously attainable only with selected units.

The LT1004 is a pin-for-pin replacement for the LM185 series of references with improved specifications. The LT1004 is an excellent device for use in systems in which accuracy was previously attained at the expense of power consumption and trimming.

The LT1004C is characterized for operation from 0°C to 70°C. The LT1004I is characterized for operation from -40°C to 85°C. The LT1004M is characterized for operation over the full military temperature range of -55°C to 125°C.

AVAILABLE OPTIONS†

TA	PACKAGED DEVICES‡			CHIP FORM (Y)
	V _Z TYP	SMALL-OUTLINE (D)	PLASTIC (LP)	
0°C to 70°C	1.2 V	LT1004CD-1.2	LT1004CLP-1.2	LT1004Y-1.2
	2.5 V	LT1004CD-2.5	LT1004CLP-2.5	LT1004Y-2.5
-40°C to 85°C	1.2 V	LT1004ID-1.2	LT1004ILP-1.2	—
	2.5 V	LT1004ID-2.5	LT1004ILP-2.5	
-55°C to 125°C	1.2 V	LT1004MD-1.2	LT1004MLP-1.2	—
	2.5 V	LT1004MD-2.5	LT1004MLP-2.5	

† For ordering purposes, the decimal point in the part number must be replaced with a hyphen (e.g., show the -1.2 suffix as -1-2 and the -2.5 suffix as -2-5).

‡ The packages are available taped and reeled. Add the R suffix to the device type (e.g., LT1004CDR).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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LT1004C-1.2, LT1004C-2.5, LT1004I-1.2, LT1004I-2.5, LT1004M-1.2

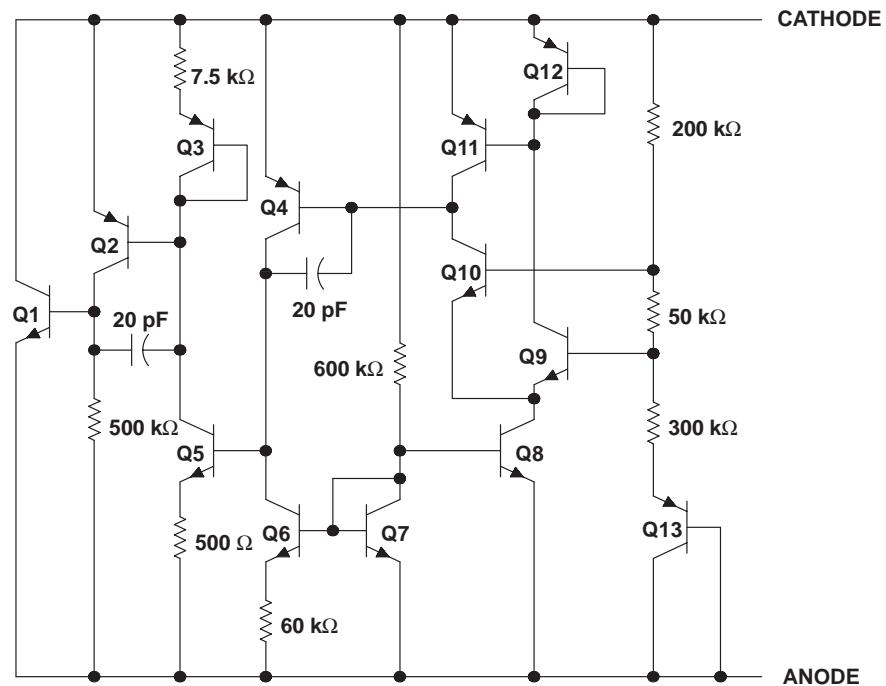
LT1004M-2.5, LT1004Y-1.2, LT1004Y-2.5

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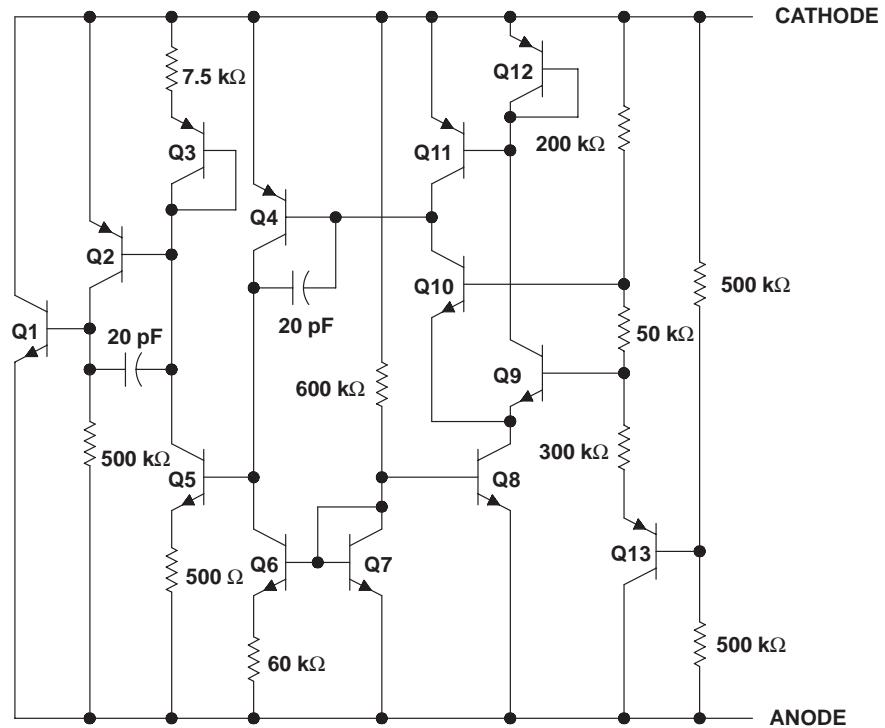
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schematic

LT1004-1.2



LT1004-2.5



NOTE A: All component values shown are nominal.

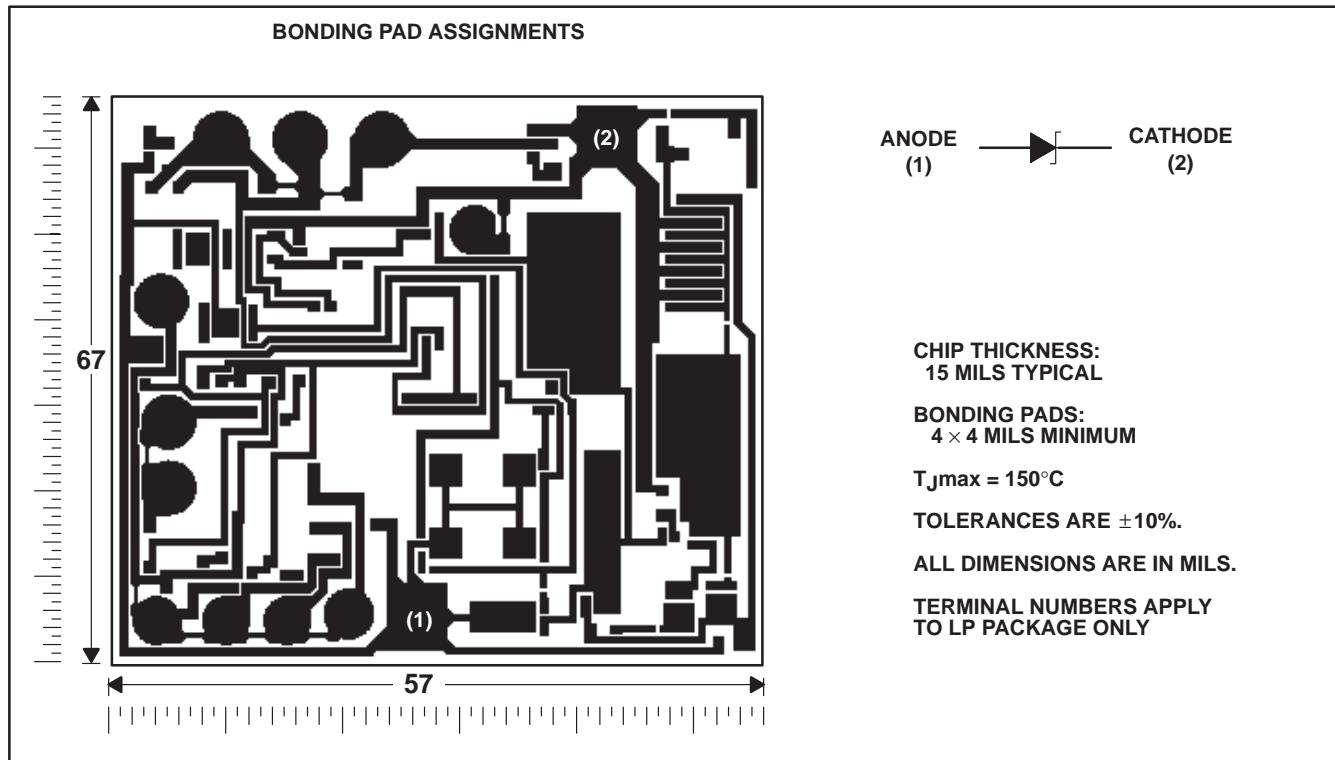
**LT1004C-1.2, LT1004C-2.5, LT1004I-1.2, LT1004I-2.5, LT1004M-1.2
LT1004M-2.5, LT1004Y-1.2, LT1004Y-2.5**

MICROPOWER INTEGRATED VOLTAGE REFERENCES

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LT1004Y-1.2 and LT1004Y-2.5 chip information

This chip, when properly assembled, displays characteristics similar to those of the LT1004C. Thermal compression or ultrasonic bonding may be used on the doped aluminum bonding pads. The chip may be mounted with conductive epoxy or a gold-silicon preform.



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Reverse current, I_R	30 mA
Forward current, I_F	10 mA
Operating free-air temperature range, T_A :	LT1004C	0°C to 70°C
	LT1004I	-40°C to 85°C
	LT1004M	-55°C to 125°C
Storage temperature range, T_{stg}	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

LT1004C-1.2, LT1004C-2.5, LT1004I-1.2, LT1004I-2.5, LT1004M-1.2

LT1004M-2.5, LT1004Y-1.2, LT1004Y-2.5

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electrical characteristics at specified free-air temperature

PARAMETER	TEST CONDITIONS	T _A [†]	LT1004-1.2			LT1004-2.5			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V _Z	Reference voltage I _Z = 100 µA	25°C	1.231	1.235	1.239	2.48	2.5	2.52	V
		Full range	LT1004C	1.225	1.245	2.47	2.5	2.53	
			LT1004I	1.225	1.245	2.47	2.5	2.53	
		LT1004M	1.215	1.245	2.46	2.535			
αV _Z	Average temperature coefficient of reference voltage [‡]	I _Z = 10 µA	25°C	20		20			ppm/°C
		I _Z = 20 µA							
ΔV _Z	Change in reference voltage with current	I _Z = I _Z min to 1 mA	25°C			1		1	mV
		Full range				1.5		1.5	
			25°C			10		10	
		I _Z = 1 mA to 20 mA	Full range			20		20	
ΔV _Z /Δt	Long term change in reference voltage	I _Z = 100 µA	25°C	20		20			ppm/khr
I _Z min	Minimum reference current		Full range	8	10	12	20		µA
z _Z	Reference impedance	I _Z = 100 µA	25°C	0.2	0.6	0.2	0.6		Ω
		Full range			1.5		1.5		
V _n	Broadband noise voltage	I _Z = 100 µA, f = 10 Hz to 10 kHz	25°C	60		120			µV

[†] Full range is 0°C to 70°C for the LT1004C, -40°C to 85°C for LT1004I, and -55°C to 125°C for the LT1004M.

[‡] The average temperature coefficient of reference voltage is defined as the total change in reference voltage divided by the specified temperature range.

electrical characteristics, T_A = 25°C

PARAMETER	TEST CONDITIONS	LT1004Y-1.2			LT1004Y-2.5			UNIT	
		MIN	TYP	MAX	MIN	TYP	MAX		
V _Z	Reference voltage	I _Z = 100 µA	1.231	1.235	1.239	2.48	2.5	2.52	V
αV _Z	Average temperature coefficient of reference voltage [†]	I _Z = 10 µA	20			20			ppm/°C
		I _Z = 20 µA							
ΔV _Z /Δt	Long-term change in reference voltage	I _Z = 100 µA	20		20			ppm/khr	
I _Z min	Minimum reference current		8		12			µA	
z _Z	Reference impedance	I _Z = 100 µA	0.2	0.6	0.2	0.6		Ω	
V _n	Broadband noise voltage	I _Z = 100 µA, f = 10 Hz to 10 kHz	60		120			µV	

[†] The average temperature coefficient of reference voltage is defined as the total change in reference voltage divided by the specified temperature range.



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TYPICAL CHARACTERISTICS[†]

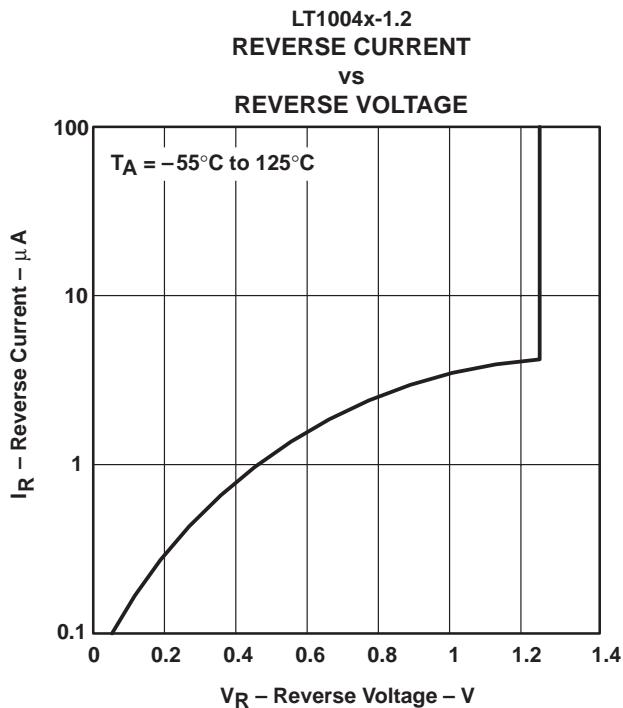


Figure 1

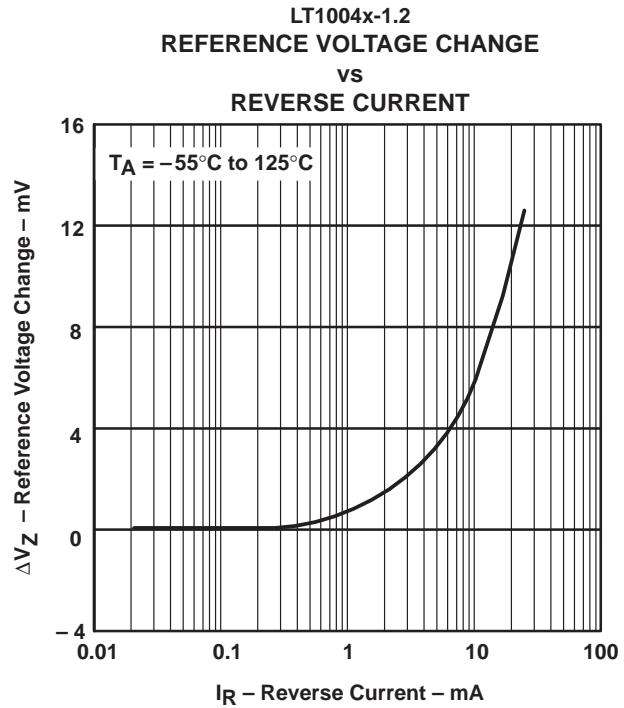


Figure 2

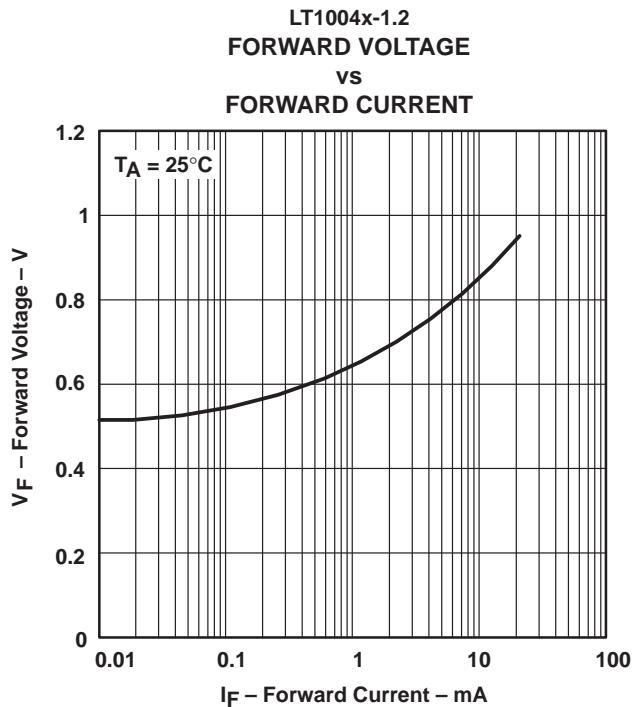


Figure 3

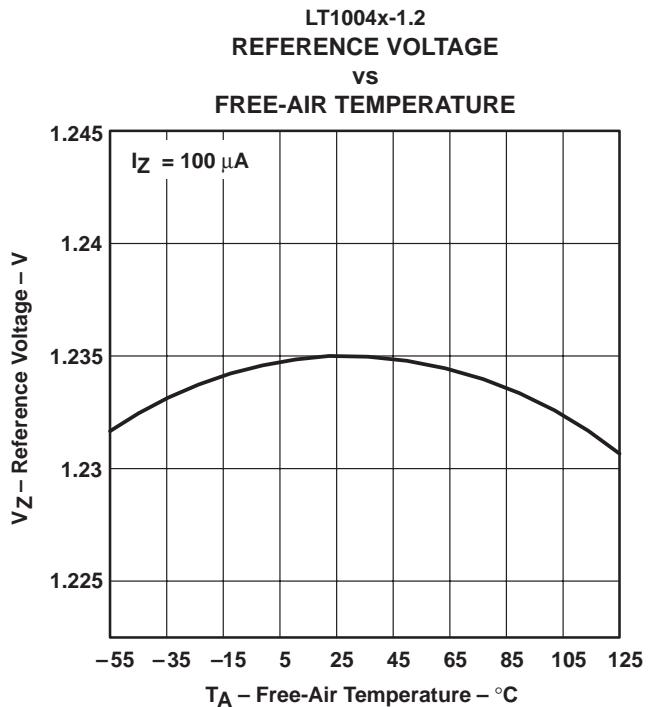


Figure 4

[†]Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

LT1004C-1.2, LT1004C-2.5, LT1004I-1.2, LT1004I-2.5, LT1004M-1.2

LT1004M-2.5, LT1004Y-1.2, LT1004Y-2.5

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TYPICAL CHARACTERISTICS[†]

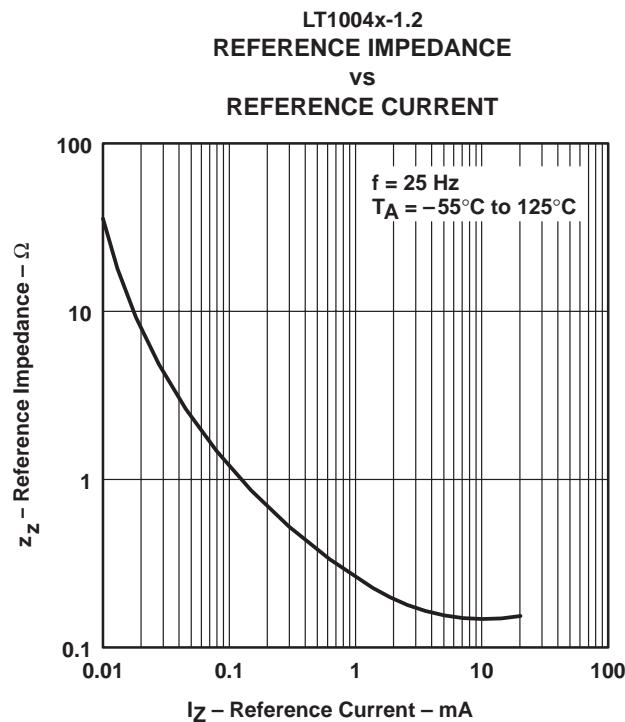


Figure 5

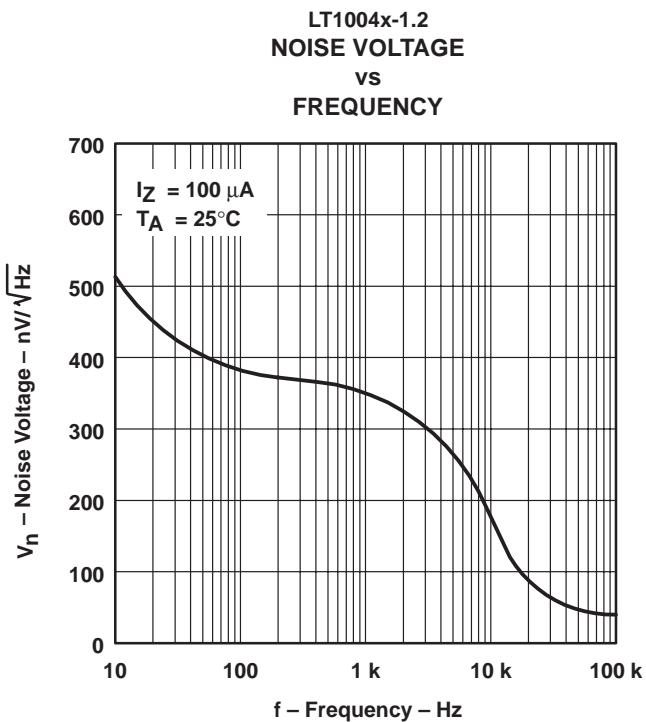


Figure 6

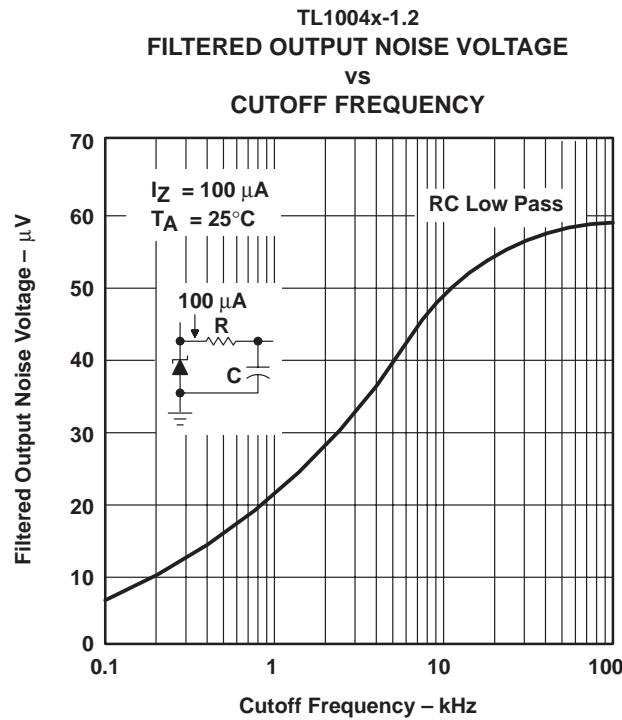


Figure 7

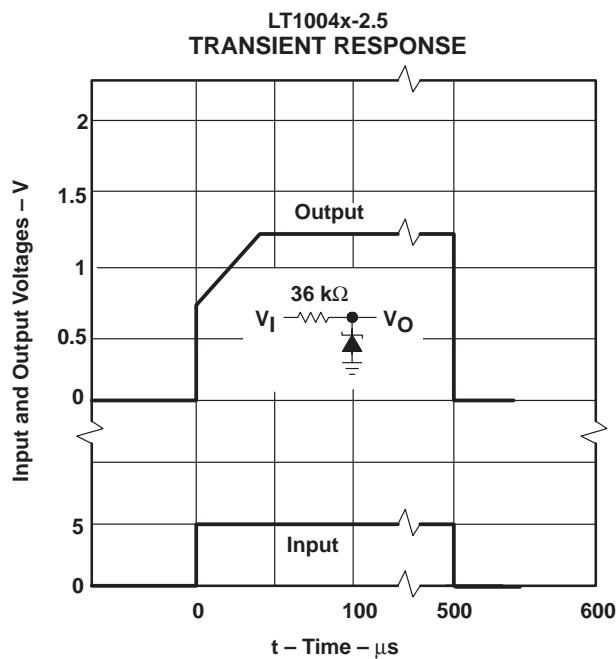


Figure 8

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS[†]

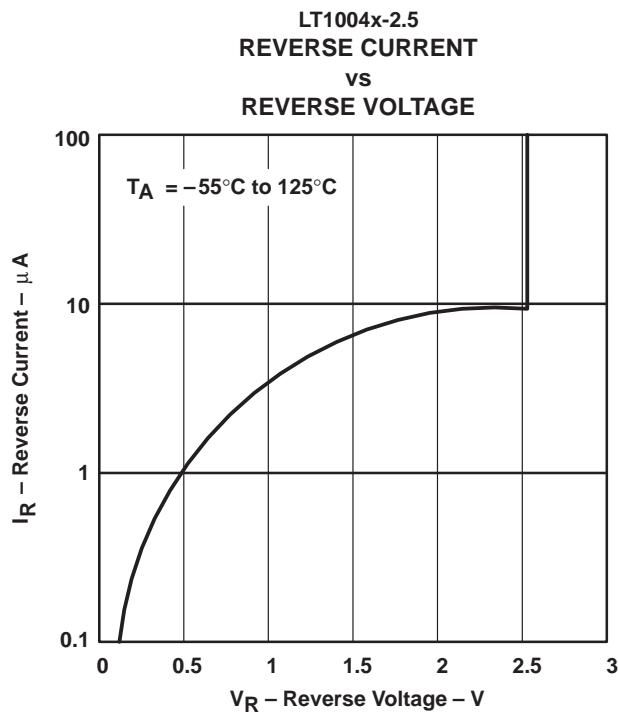


Figure 9

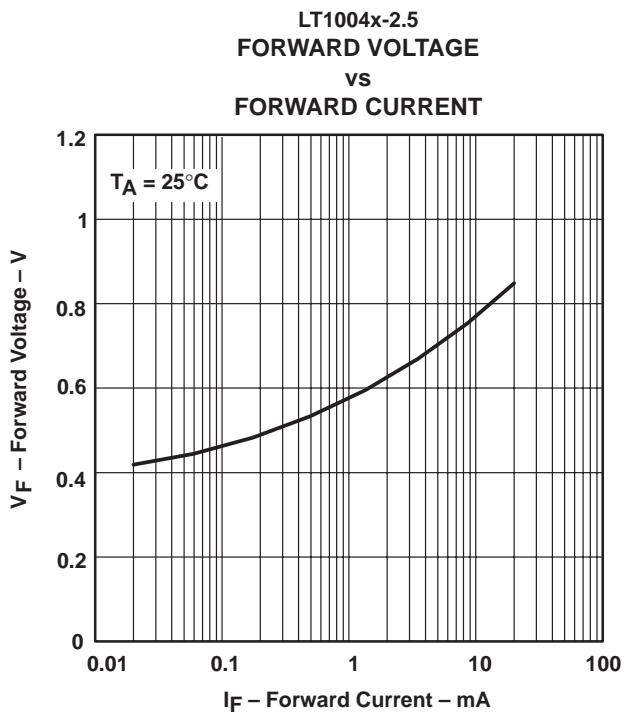


Figure 10

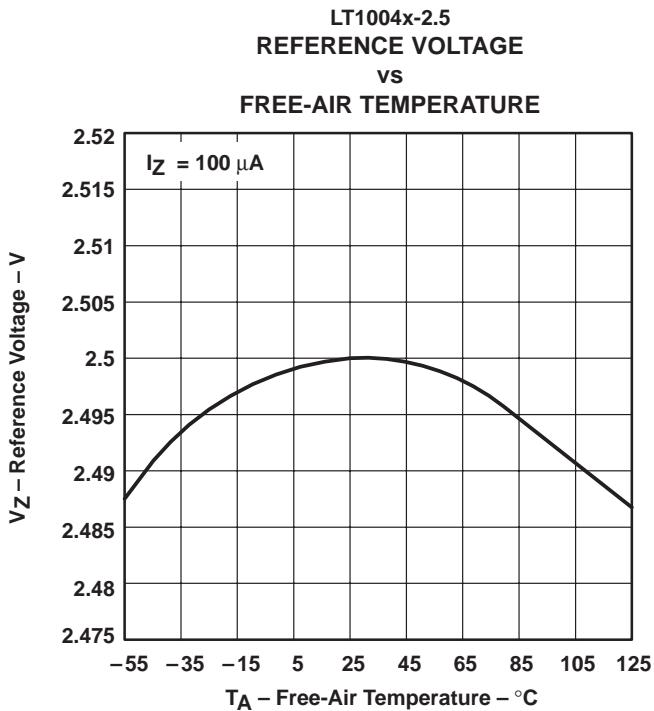


Figure 11

[†]Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

LT1004C-1.2, LT1004C-2.5, LT1004I-1.2, LT1004I-2.5, LT1004M-1.2

LT1004M-2.5, LT1004Y-1.2, LT1004Y-2.5

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TYPICAL CHARACTERISTICS[†]

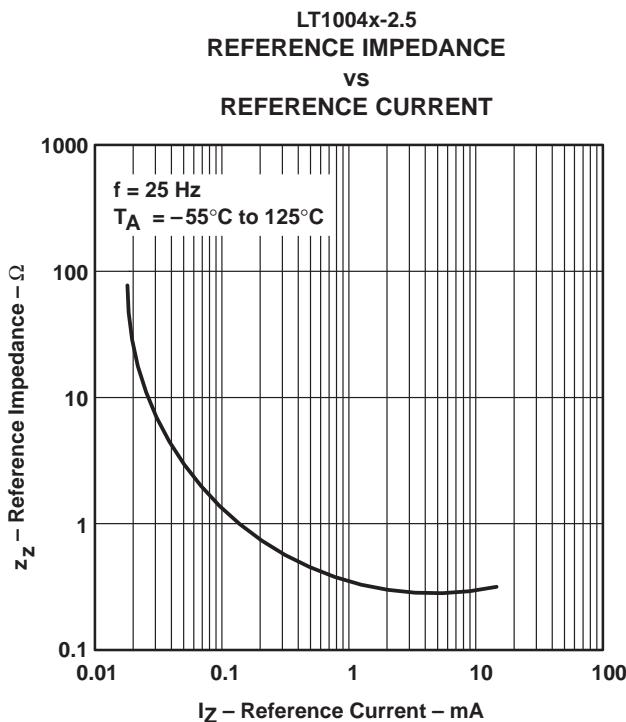


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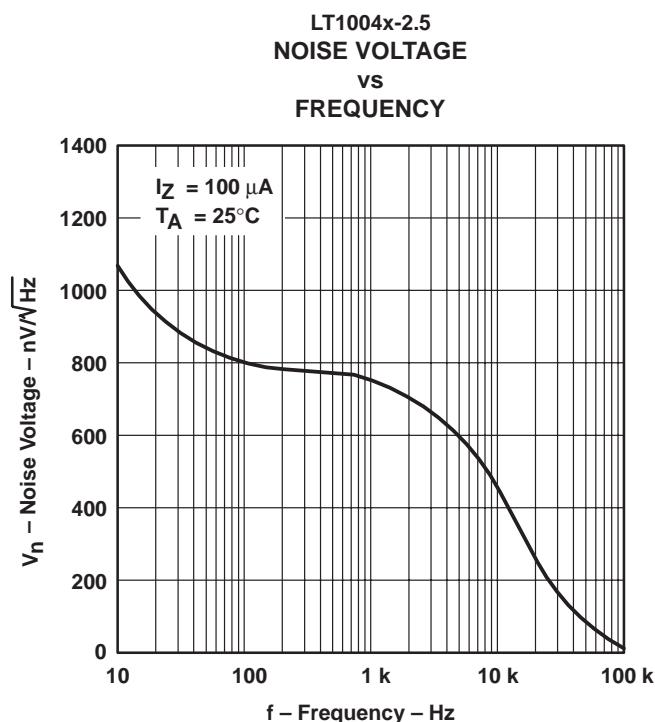


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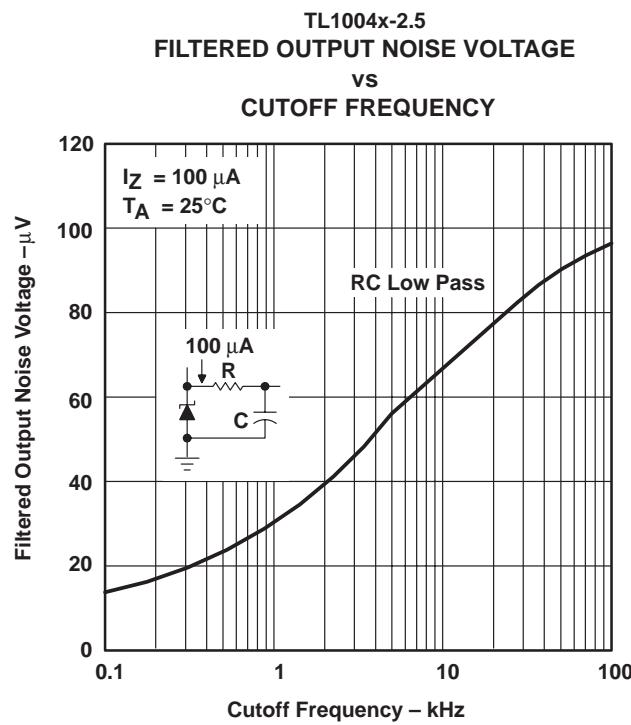


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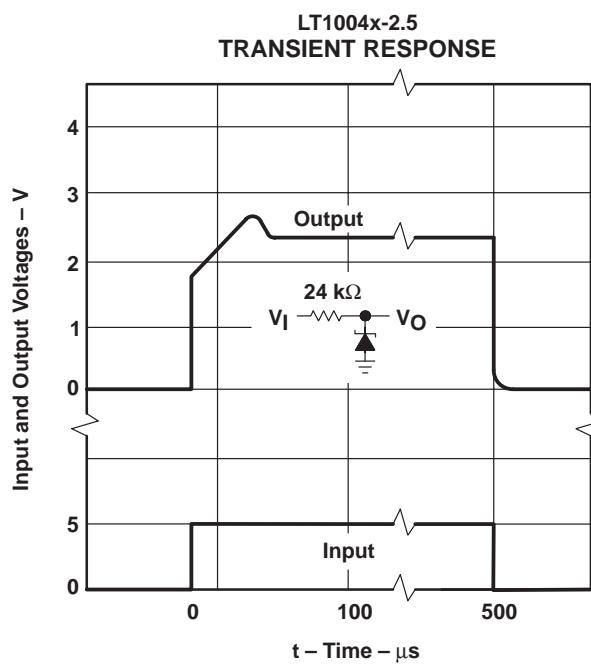


Figure 15

[†]Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

APPLICATION INFORMATION

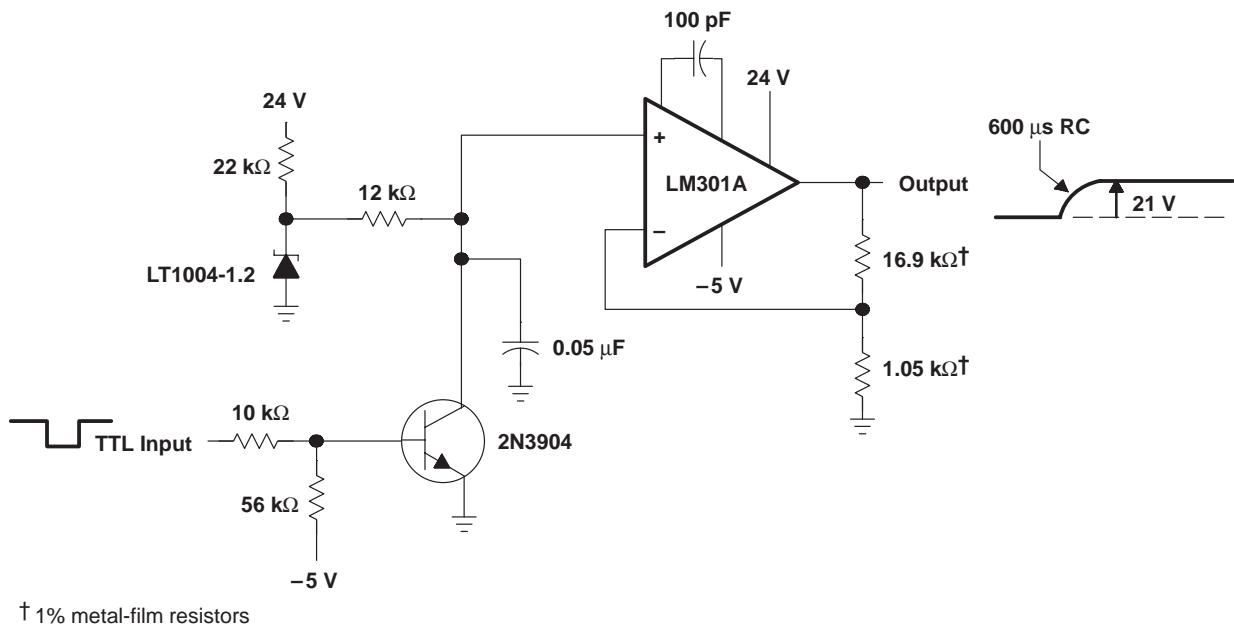


Figure 16. $V_{I(PP)}$ Generator for EPROMs (No Trim Required)

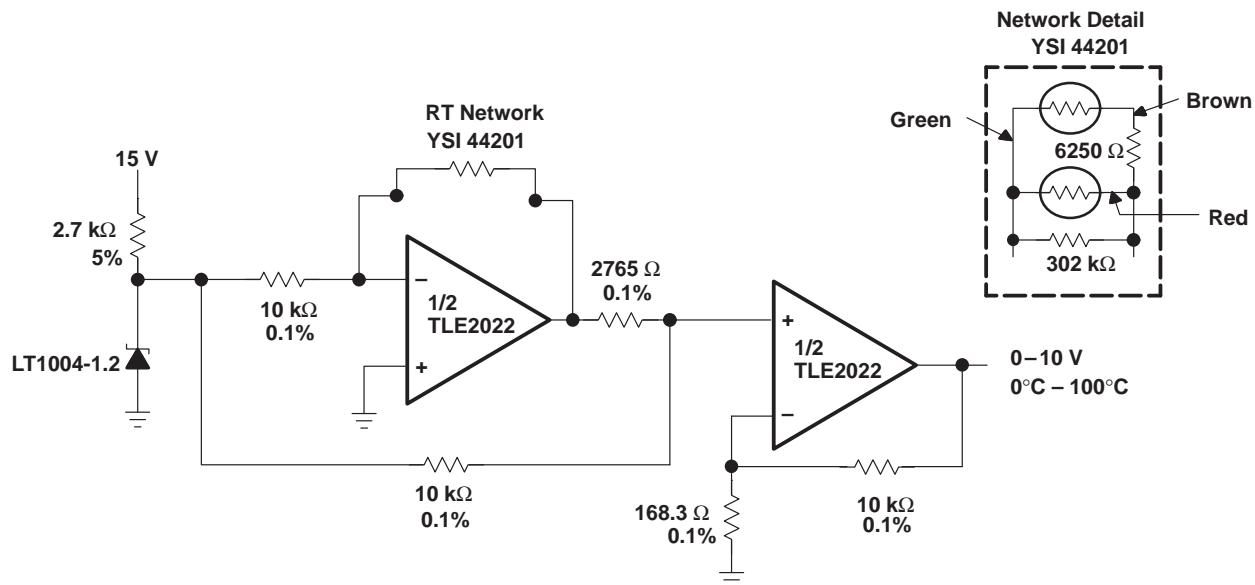


Figure 17. 0°C to 100°C Linear Output Thermometer

LT1004C-1.2, LT1004C-2.5, LT1004I-1.2, LT1004I-2.5, LT1004M-1.2

LT1004M-2.5, LT1004Y-1.2, LT1004Y-2.5

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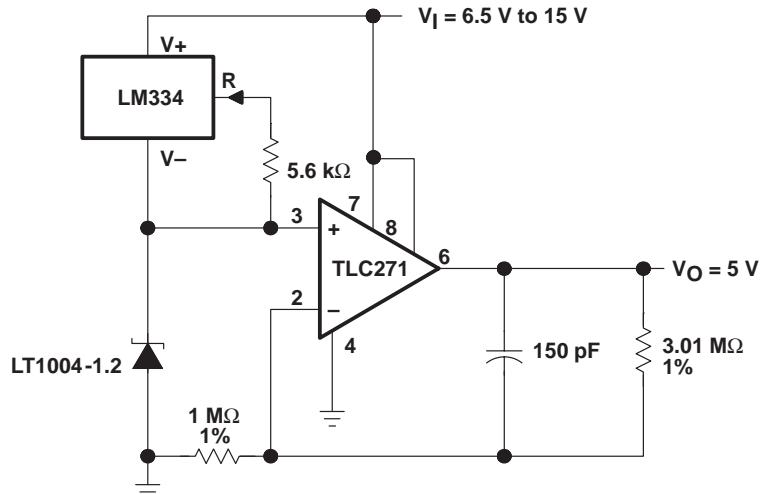


Figure 18. Micropower 5-V Reference

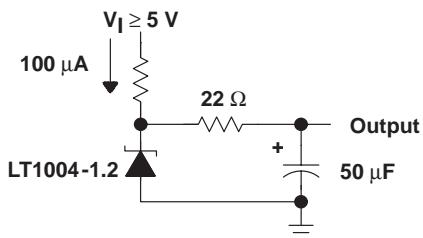


Figure 19. Low-Noise Reference

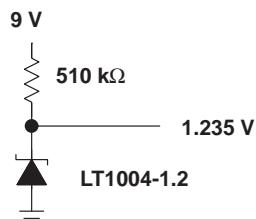
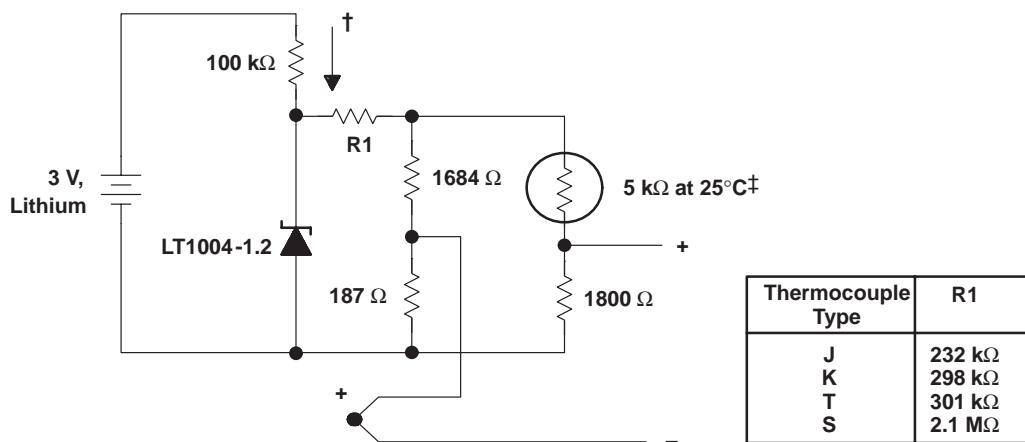


Figure 20. Micropower Reference From 9-V Battery



† Quiescent current $\leq 15 \mu\text{A}$

‡ Yellow Springs Inst. Co., Part #44007

NOTE A: This application compensates within $\pm 1^\circ\text{C}$ from 0°C to 60°C .

Figure 21. Micropower Cold-Junction Compensation for Thermocouples

APPLICATION INFORMATION

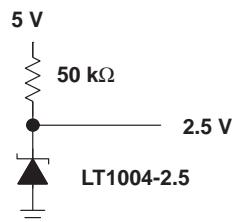


Figure 22. 2.5-V Reference

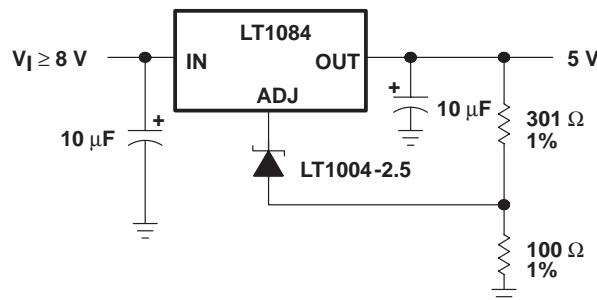
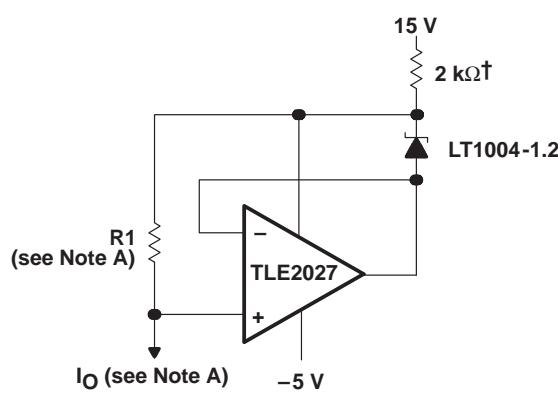


Figure 23. High-Stability 5-V Regulator



† May be increased for small output currents

$$\text{NOTE A: } R_1 \approx \frac{2\text{ V}}{I_O + 10\text{ }\mu\text{A}}, \quad I_O = \frac{1.235\text{ V}}{R_1}$$

Figure 24. Ground-Referenced Current Source

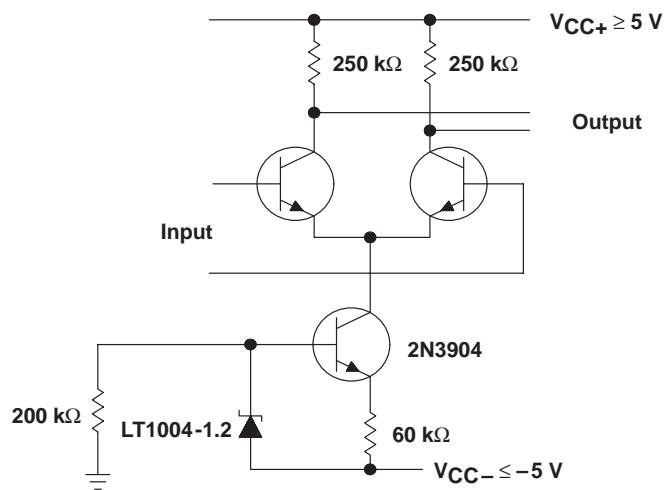
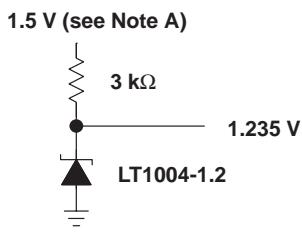


Figure 25. Amplifier With Constant Gain Over Temperature



NOTE A: Output regulates down to 1.285 V for $I_O = 0$.

Figure 26. 1.2-V Reference from 1.5-V Battery

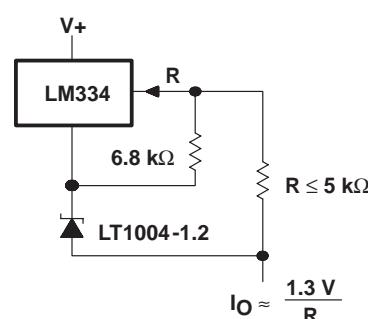


Figure 27. Terminal Current Source With Low Temperature Coefficient

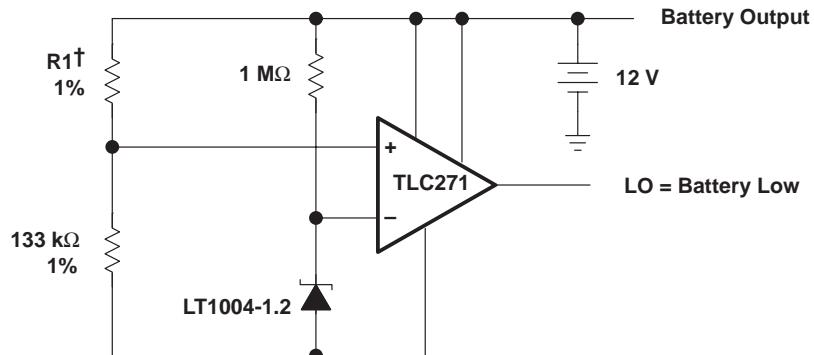
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LT1004M-2.5, LT1004Y-1.2, LT1004Y-2.5

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APPLICATION INFORMATION



†R1 sets trip point, 60.4 kΩ per cell for 1.8 V per cell

Figure 28. Lead-Acid Low-Battery Voltage Detector

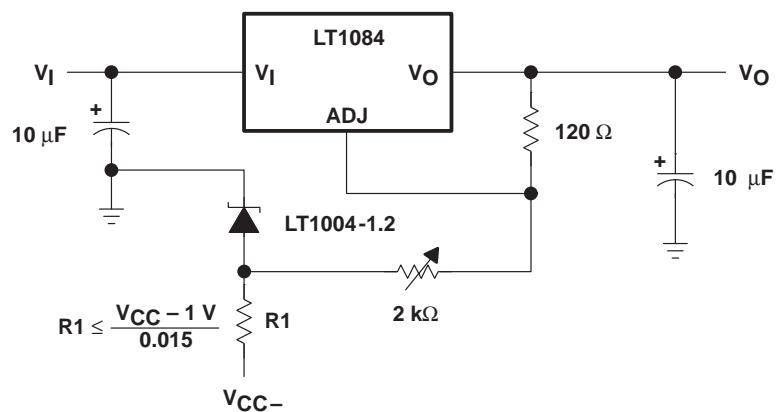


Figure 29. Variable Voltage Supply

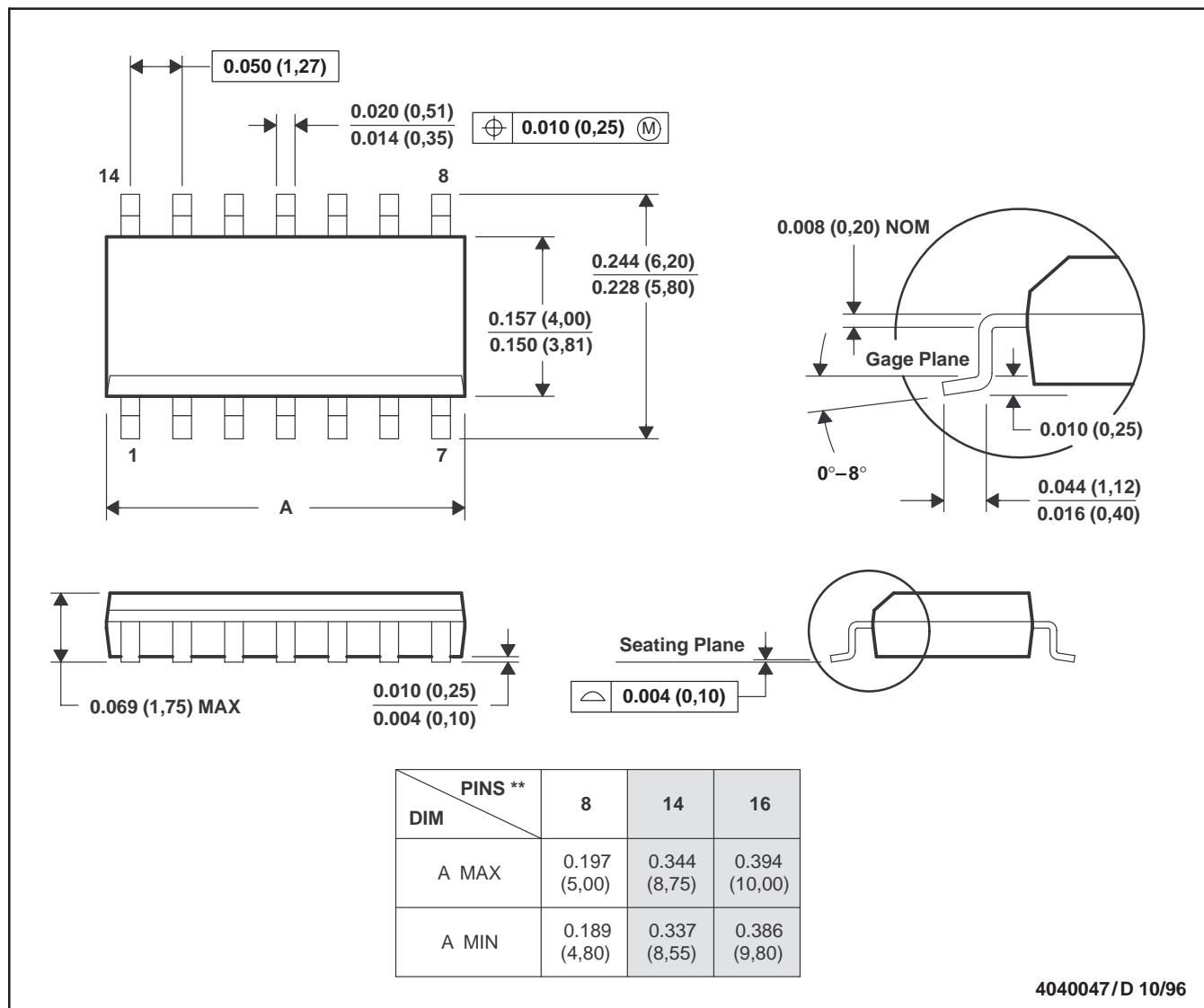
**LT1004C-1.2, LT1004C-2.5, LT1004I-1.2, LT1004I-2.5, LT1004M-1.2
LT1004M-2.5, LT1004Y-1.2, LT1004Y-2.5**
MICROPOWER INTEGRATED VOLTAGE REFERENCES
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MECHANICAL DATA

D (R-PDSO-G)**

PLASTIC SMALL-OUTLINE PACKAGE

14 PIN SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
 D. Falls within JEDEC MS-012

LT1004C-1.2, LT1004C-2.5, LT1004I-1.2, LT1004I-2.5, LT1004M-1.2

LT1004M-2.5, LT1004Y-1.2, LT1004Y-2.5

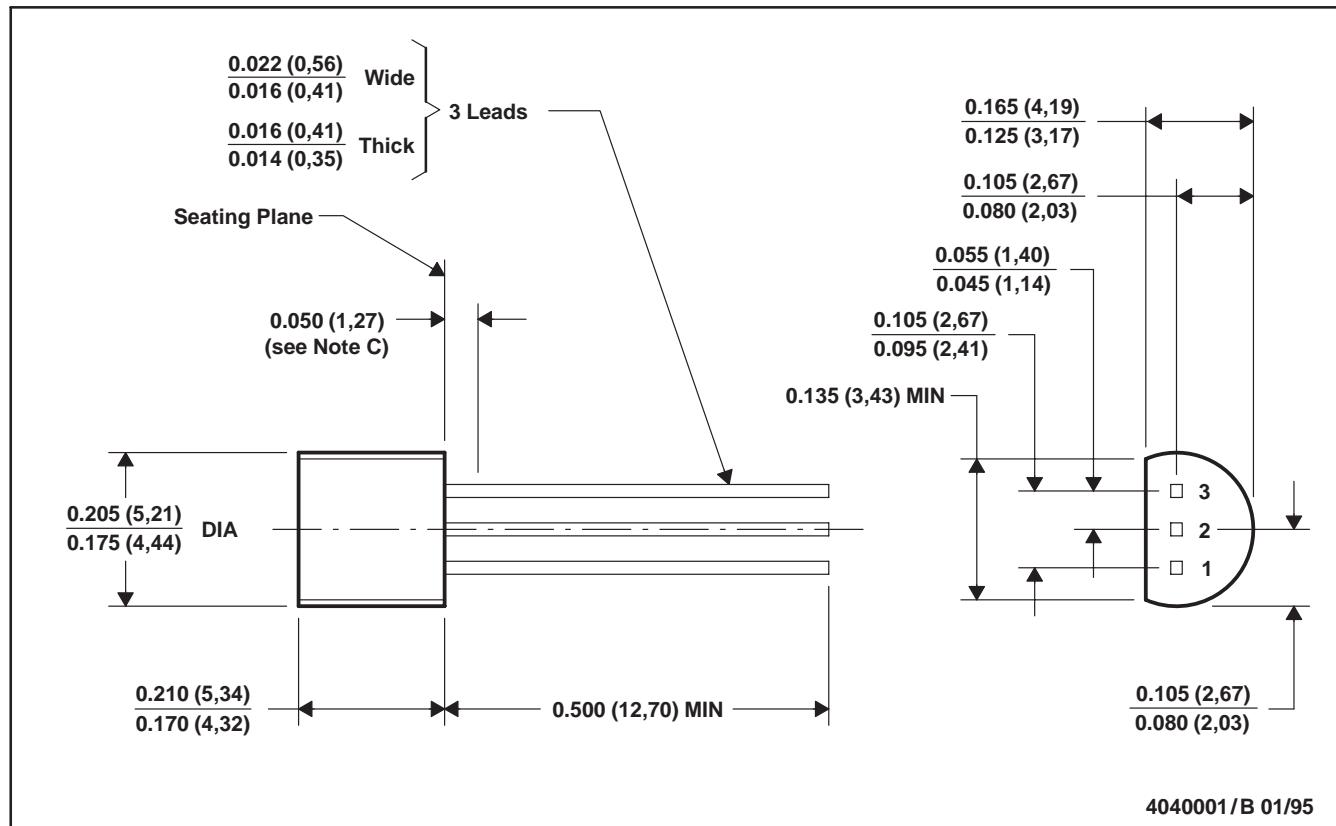
MICROPOWER INTEGRATED VOLTAGE REFERENCES

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MECHANICAL DATA

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Lead dimensions are not controlled within this area.
 - D. Falls within JEDEC TO-226AA (TO-226AA replaces TO-92)

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